



Click [here](#) for the 3D model.

Dimensions	
Chip Size	1206
L	3.07mm +/-0.38mm (0.121 in +/-0.015 in)
W	1.52mm +/-0.38mm (0.06 in +/-0.015 in)
T	1.6mm MAX (0.063 in MAX)
B	0.51mm +/-0.25mm (0.02 in +/-0.01 in)

Packaging Specifications	
Packaging	T&R, Plastic Tape

General Information	
Series	GR900 SMD Space
Style	SMD Chip
RoHS	Yes
Termination	Tin
Failure Rate	N/A
Testing and Reliability	GR900 CSAM A
AEC-Q200	No
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	160 pF
Capacitance Tolerance	5%
Voltage DC	200 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BP

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.